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3806 Group, 3886 Group

Differences between 3806 Group and 3886 Group

1. Differences between 3806 Group and 3886 Group

			3806 Group	3886 Group	Additional Register in 3886 Group	
Minimum Instruction Execution Time			0.5 μs in Standard ver. 0.4 μs in High-speed ver. (at max. 8 MHz oscillation frequency)	0.4 μs (at max. 10 MHz oscillation frequency)	tion —	
Sub-clock Oscillating Circuit		lating	_	Composed of P40/XCOUT and P41/XCIN	CPU mode register (bits 4, 6, 7 at address 003B16)	
Internal System Clock φ		ι Clock φ	f(XIN) / 2, only	f(XIN) / 2 in high-speed mode, f(XIN) / 8 in middle-speed mode, f(XCIN) / 2 in low-speed mode	CPU mode register (bits 4 to 7 at address 003B16); *MCU starts in middle-speed mode after releasing Reset.	
Interrupt			16 sources, 16 vectors (external 7, internal 8, software 1)	21 sources, 16 vectors (external 9, internal 11, software 1)	_	
Watchdog Timer		r	_	16-bit × 1	Watchdog timer control register (address 001E16)	
LED Direct Drive Port		e Port	_	4 pins, P24 to P27; IOL(peak) = 20 mA, $\Sigma IOL(peak) = 80 \text{ mA},$ IOL(avg) = 15 mA, $\Sigma IOL(avg) = 40 \text{ mA}$	Port control register 1 (address 002E16), Port control register 2 (address 002F16)	
Softwar	Software Pull-up Resistors		_	Included in port P3, Programmable for each 4-bit unit	Port control register 1 (bits 4, 5 at address 002E16)	
A-D Co	A-D Converter F		8-bit	10-bit	_	
		Channel	8 channels, P60 to P67	8 channels; P60 to P67	_	
Timer	Structu	ıre	Prescaler 12 (8-bit) →Timer 1 (8-bit) →Timer 2 (8-bit) Prescaler X (8-bit) →Timer X (8-bit) Prescaler Y (8-bit) →Timer Y (8-bit)	Prescaler 12 (8-bit) →Timer 1 (8-bit) →Timer 2 (8-bit) Prescaler X (8-bit) →Timer X (8-bit) Prescaler Y (8-bit) →Timer Y (8-bit)	_	
Count source		source	f(XIN) / 16, only	f(XIN) / 16 for Timers 1, 2, X; Selectable f(XIN)/16 or f(XCIN) for Timer Y in Timer mode, Pulse output mode	Port control register 2 (bit 5 at address 002F16)	
Serial I/O1 (UART/Clock synchronous)		RT/Clock	8-bit × 1 channel, P44 to P47 used	8-bit × 1 channel, P44 to P47 used	_	
Serial I/O2 (Clock synchronous)		nous)	8-bit × 1 channel, P70 to P73 used	8-bit × 1 channel, P70 to P73 used	_	
PWM		_		14-bit × 2 channels	Port control register 1 (bits 6, 7 at address 002E16) PWM0H register (address 003016) PWM0L register (address 003116) PWM1H register (address 003216) PWM1L register (address 003316) AD/DA control register (bits 4, 5 at address 003416)	
D-A Converter			8-bit × 2 channels	8-bit × 2 channels	_	

[•] The above mentioned (*) shows that it differs from 3806 Group.



3806 Group, 3886 Group Differences between 3806 Group and 3886 Group

	3806 Group	3886 Group	Additional Register in 3886 Group
Bus Interface	_	2 bytes	Data bus buffer register 0 (address 002816) Data bus buffer status register 0 (address 002916) Data bus buffer control register (address 002A16) Data bus buffer register 1 (address 002B16) Data bus buffer status register 1 (address 002C16) Port control register 2 (bit 2 at address 002F16)
I ² C-Bus Interface		1 channel	I ² C data shift register (address 001216) I ² C address register (address 001316) I ² C status register (address 001416) I ² C control register (address 001516) I ² C clock control register (address 001616) I ² C start/stop condition control register (address 001716)
Comparator Circuit	_	8 channels	Comparator data register (address 002D16) Serial I/O2 control register (bit 7 at address 001D16)
N-channel Open-drain Pin	P70 to P77	P00 to P07, P10 to P17, P42 to P46	Port control register 1 (bits 0 to 3 at address 002E16) Port control register 2 (bit 2 at address 002F16)

2. Reference

Data Sheet

3886 Group Datasheet

3806 Group Datasheet

User's Manual

3886 Group USER'S MANUAL

3806 Group USER'S MANUAL

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Revision Record

Description

Rev.	Date	Page	Summary
1.00	Nov.10.00	_	Issue as reference selection.
1.01	Mar.18.05	_	Change to application note format and issue



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